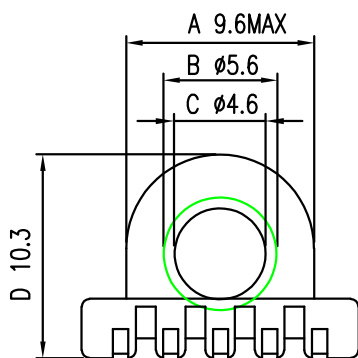




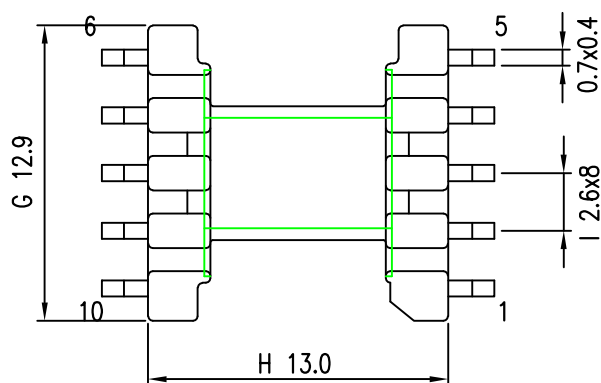
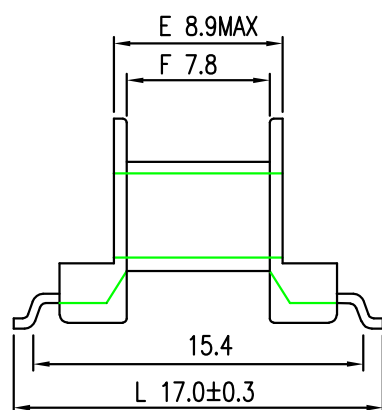
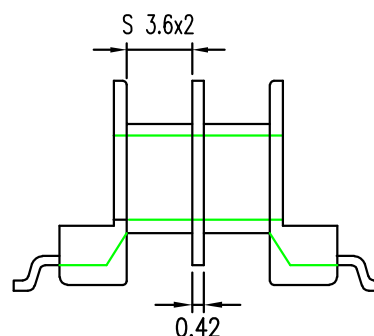
台灣高分子工業股份有限公司
TAIWAN POLYMER INDUSTRIAL CO., LTD.

PRODUCT SPEC.

TPI NO.: SEP1304



TPI NO.: SEP1305



DATE	REVISED STORY	MODEL : EP-13-10PIN-1SEC SMD (TPI NO.:SEP1304) EP-13-10PIN-2SEC SMD (TPI NO.:SEP1305)		
6/01'02	RELEASED THE NEW DRAWING SPEC.	BOBBIN MATERIAL : PHENOLIC RESIN UL94V-0 PIN MATERIAL : PHOSPHORUS BRONZE (TIN PLATED)		
8/01'20	REMOVE CLAMP			
		DATE : AUG 01,2020	REV. : B	TOLERANCE : .XXX±0.08 .XX ±0.1 .X ±0.2